

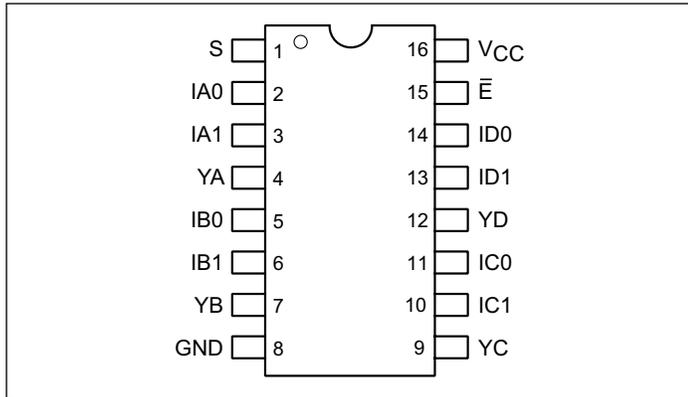
PI5C3257

Quad 2:1 Mux/DeMux Bus Switch

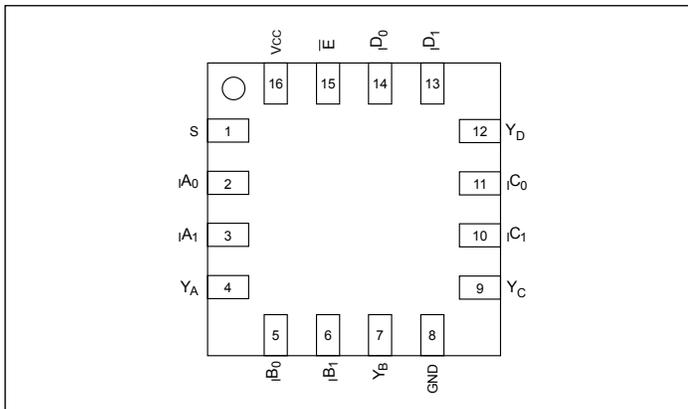
Features

- Near-Zero propagation delay
- 5Ω switches connect inputs to outputs
- Direct bus connection when switches are ON
- Ultra Low Quiescent Power (0.2μA typical)
 - Ideally suited for notebook applications
- Pin compatible with 74 series 257 logic devices
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. “Green” Device (Note 3)
- Packaging (Pb-free & Green available):
 - 16-pin, QSOP (Q)
 - 16-pin, TSSOP (L)
 - 16-pin, UQFN (ZHD)

Pin Configuration (QSOP, TSSOP)



Pin Configuration (UQFN)



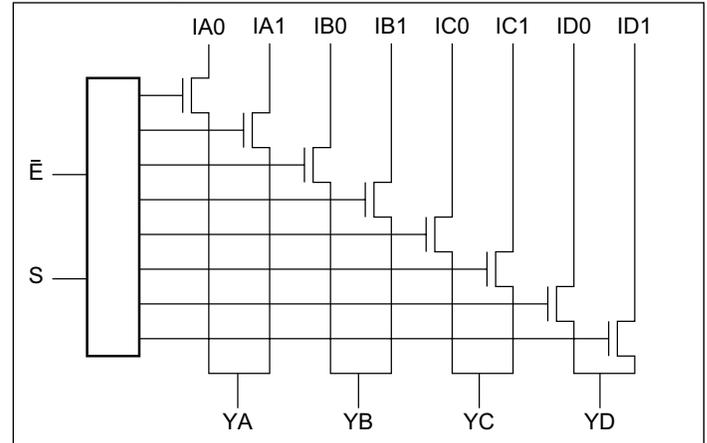
Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated’s definitions of Halogen- and Antimony-free, “Green” and Lead-free.
3. Halogen- and Antimony-free “Green” products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Description

The PI5C3257 is a Quad 2:1 multiplexer/demultiplexer with three-state outputs that is pinout and function compatible with the PI74FCT257T, 74F257, and 74ALS/AS/LS257. Inputs can be connected to outputs with low On-Resistance (5Ω) with no additional ground bounce noise or propagation delay.

Block Diagram



Truth Table⁽¹⁾

\bar{E}	S	YA	YB	YC	YD	Function
H	X	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Disable
L	L	IA0	IB0	IC0	ID0	S = 0
L	H	IA1	IB1	IC1	ID1	S = 1

Note:

1. H = High Voltage Level, L = Low Voltage Level

Pin Description

Pin Name	Description
IA _n -ID _n	Data Inputs
S	Select Inputs
\bar{E}	Enable
YA-YD	Data Outputs
GND	Ground
V _{CC}	Power

Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	-65°C to +150°C
Ambient Temperature with Power Applied	-40°C to +85°C
Supply Voltage to Ground Potential (Inputs & V _{CC} Only)....	-0.5V to +7.0V
Supply Voltage to Ground Potential (Outputs & D/O Only) .-	-0.5V to +7.0V
DC Input Voltage	-0.5V to +7.0V
DC Output Current.....	120mA
Power Dissipation	0.5W

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC Electrical Characteristics (Over the Operating Range, T_A = -40°C to +85°C, V_{CC} = 5V ±5%)

Parameters	Description	Test Conditions ⁽¹⁾	Min.	Typ. ⁽²⁾	Max.	Units
V _{IH}	Input HIGH Voltage	Guaranteed Logic HIGH Level	2.0			V
V _{IL}	Input LOW Voltage	Guaranteed Logic LOW Level	-0.5		0.8	
I _{IH}	Input HIGH Current	V _{CC} = Max., V _{IN} = V _{CC}			±1	µA
I _{IL}	Input LOW Current	V _{CC} = Max., V _{IN} = GND			±1	
I _{OZH}	High Impedance Output Current	0 ≤ I, Y ≤ V _{CC}			±1	
V _{IK}	Clamp Diode Voltage	V _{CC} = Min., I _{IN} = -18 mA		-0.7	-1.2	V
I _{OS}	Short Circuit Current ⁽³⁾	I (Y) = 0V, Y (I) = V _{CC}	100			mA
V _H	Input Hysteresis at Control Pins			150		mV
R _{ON}	Switch On-Resistance ⁽⁴⁾	V _{CC} = Min., V _{IN} = 0.0V, I _{ON} = 48mA		5	7	Ω
		V _{CC} = Min., V _{IN} = 2.4V, I _{ON} = 15mA		10	15	

Notes:

- For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at V_{CC} = 5.0V, T_A = 25°C ambient and maximum loading.
- Not more than one output should be shorted at one time. Duration of the test should not exceed one second.
- Measured by the voltage drop between I and Y pin at indicated current through the switch. On-Resistance is determined by the lower of the voltages on the two (I, Y) pins.

Capacitance (T_A = 25°C, f = 1 MHz)

Parameters ⁽¹⁾	Description	Test Conditions	Typ.	Max.	Units
C _{IN}	Input Capacitance	V _{IN} = 0V		6	pF
C _{OFF}	In/Yn Capacitance, Switch Off			6	
C _{ON}	In/Yn Capacitance, Switch On			14	

Notes:

- This parameter is determined by device characterization but is not production tested.

Power Supply Characteristics

Parameters	Description	Test Conditions ⁽¹⁾		Min.	Typ. ⁽²⁾	Max.	Units
I _{CC}	Quiescent Power Supply Current	V _{CC} = Max.	V _{IN} = GND or V _{CC}		0.1	3.0	μA
ΔI _{CC}	Supply Current per Input @ TTL HIGH	V _{CC} = Max.	V _{IN} = 3.4V ⁽³⁾			2.5	mA
I _{CCD}	Supply Current per Input per MHz ⁽⁴⁾	V _{CC} = Max., I and Y Pins Open \overline{BE} = GND Control Input Toggling 50% Duty Cycle				0.25	mA/ MHz

Notes:

1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device.
2. Typical values are at V_{CC} = 5.0V, +25°C ambient.
3. Per TTL driven input (V_{IN} = 3.4V, control inputs only); I and Y pins do not contribute to I_{CC}.
4. This current applies to the control inputs only and represent the current required to switch internal capacitance at the specified frequency. The I and Y inputs generate no significant AC or DC currents as they transition. This parameter is not tested, but is guaranteed by design.

Switching Characteristics over Operating Range

Parameters	Description	Conditions	Com.		Units
			Min.	Max.	
t _{IY}	Propagation Delay ^(1,2) In to Yn	C _L = 50pF R _L = 500Ω		0.25	ns
t _{SY}	Bus Select Time S _n to Yn		0.5	5.2	
t _{PZH} t _{PZL}	Bus Enable Time \overline{E} to Yn		0.5	4.8	
t _{PHZ} t _{PLZ}	Bus Disable Time \overline{E} to Yn		0.5	5.0	

Notes:

1. This parameter is guaranteed but not tested on Propagation Delays.
2. The bus switch contributes no propagational delay other than the RC delay of the On-Resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.25ns for 50pF load. Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagational delay to the system. Propagational delay of the bus switch when used in a system is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

PI5C3257

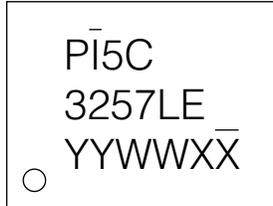
Part marking

Q Package



Y: Year
W: Workweek
1st X: Assembly Site Code
2nd X: Fab Site Code
Bar above "I" means Fab3 of MGN
Bar above fab code means Cu wire

L Package



YY: Year
WW: Workweek
1st X: Assembly Site Code
2nd X: Fab Site Code
Bar above "I" means Fab3 of MGN
Bar above fab code means Cu wire

ZHD Package

wG = PI5C3257ZHDE



Y: Year
W: Workweek
1st X: Assembly Site Code
2nd X: Fab Site Code
Bar above "G" means Fab3 of MGN
Bar above 2nd "X" means Cu wire

PI5C3257

Packaging Mechanical: 16-QSOP (Q)

SYMBOLS	MIN.	NOM.	MAX.
A	—	—	0.069
A1	0.004	—	0.0098
A2	0.049	—	—
b	0.008	—	0.012
c	0.004	—	0.010
D	0.189	0.193	0.197
E1	0.150	0.154	0.158
E	0.228	0.236	0.244
L	0.016	—	0.050
L1	0.041 REF.		
e	0.025 BSC.		
θ°	0	—	8

UNIT : INCH

NOTES:
 1. ALL DIMENSIONS IN INCH. ANGLES IN DEGREES.
 2. JEDEC MO-137E
 3. DIMENSIONS DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

PERICOM[®]
Enabling Serial Connectivity

DATE: 04/08/16

DESCRIPTION: 16-Pin, 150mil Wide QSOP

PACKAGE CODE: Q (Q16)

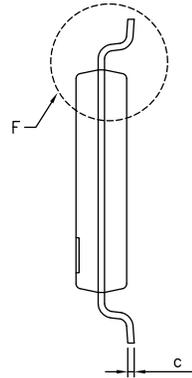
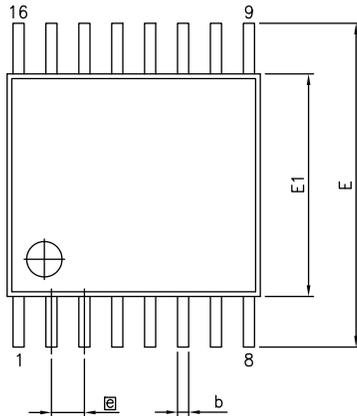
DOCUMENT CONTROL #: PD-1201

REVISION: H

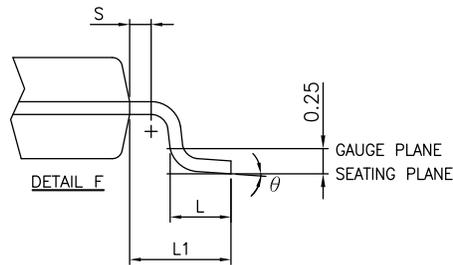
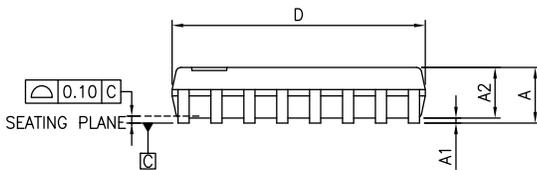
16-0056

PI5C3257

Packaging Mechanical: 16-TSSOP (L)



SYMBOLS	MIN.	NOM.	MAX.
A	—	—	1.20
A1	0.05	—	0.15
A2	0.80	1.00	1.05
b	0.19	—	0.30
c	0.09	—	0.20
D	4.90	5.00	5.10
E1	4.30	4.40	4.50
E	6.20	6.40	6.60
e	0.65 BSC		
L1	1.00 REF		
L	0.45	0.60	0.75
S	0.20	—	—
θ	0°	—	8°



NOTES:

1. ALL DIMENSIONS IN MILLIMETERS. ANGLES IN DEGREES.
2. JEDEC MO-153F
3. DIMENSIONS DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.



DATE: 03/24/16

DESCRIPTION: 16-Pin, 173mil Wide TSSOP

PACKAGE CODE: L (L16)

DOCUMENT CONTROL #: PD-1310

REVISION: G

16-0061

PI5C3257

Packaging Mechanical: 16-UQFN (ZHD)

Top View: Shows overall dimensions D and E, and the PIN1 Index Area.

Bottom View: Shows pin locations N1 through N16, dimensions D1, E1, and e.

Side View: Shows dimensions A, A1, and A3.

RECOMMENDED LAND PATTERN(unit:mm): Shows a 16x16 grid with dimensions 0.70x16, 1.60, 1.60, 16X0.27, 2.90, and 0.50BSC.

PKG. DIMENSIONS(MM)		
SYMBOL	Min	Max
A	0.50	0.65
A1	0.00	0.05
A3	0.15 REF	
D	2.90	3.10
E	2.90	3.10
D1	1.60	1.90
E1	1.60	1.90
b	0.18	0.30
e	0.50 BSC	
L	0.25	0.55

Note:
1. Comply with MO-248E, except 'L' MIN and 'L' 'D1' 'E1' MAX

DIODES INCORPORATED	PERICOM PERIPHERAL SERIAL CHARACTERISTICS	DATE: 07/27/16
DESCRIPTION: 16-Pin, UQFN, 3X3		
PACKAGE CODE: ZHD(ZHD16)		
DOCUMENT CONTROL#: PD-2209		REVISION: --

16-0092

For latest package info.

please check: <http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/>

Ordering Information

Ordering Code	Packaging Code	Package Description
PI5C3257QEX	Q	16-pin, 150-mil Wide (QSOP)
PI5C3257LEX	L	16-pin, 173-mil Wide (TSSOP)
PI5C3257ZHDEX	ZHD	16-pin, 3x3 (UQFN)

Notes:

- No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- E = Pb-free and Green
- X suffix = Tape/Reel

IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.

Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and definitive format released by Diodes Incorporated.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or

2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2016, Diodes Incorporated

www.diodes.com

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Diodes Incorporated:](#)

[PI3B16233AE](#)